

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number: [0442480029](#)
Status: **Active**
Overview: [modular_plugs_jacks](#)
Description: Modular Jack, Right Angle, Low Profile, Inverted, Lightpipes, 8/8, 2 Ports

Documents:
[3D Model](#) [Product Specification PS-43860-003 \(PDF\)](#)
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

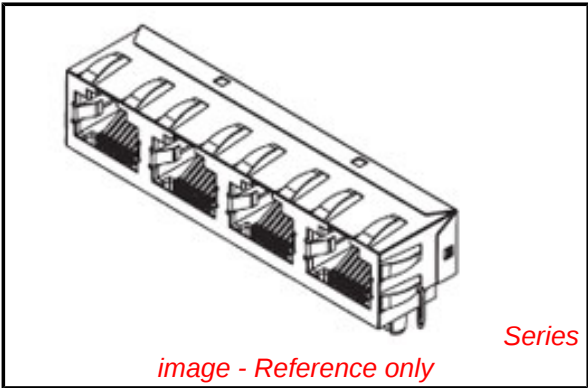
CSA LR19980
UL E107635

General

Product Family Modular Jacks/Plugs
Series [44248](#)
Comments Industry Compatible
Component Type PCB Jack
Magnetic No
Overview [modular_plugs_jacks](#)
Performance Category 3
Power over Ethernet (PoE) N/A
Product Name RJ45

Physical

Boot Color N/A
Color - Resin Black, Clear
Durability (mating cycles max) 500
Flammability 94V-0
Inverted / Top Latch Yes
Lightpipes/LEDs Lightpipes
Material - Metal Phosphor Bronze
Material - Plating Mating Gold
Material - Plating Termination Tin
Material - Resin Polycarbonate, Polyester
Orientation Right Angle (Side Entry)
PCB Locator Yes
PCB Retention Yes
PCB Thickness Recommended (in) 0.062 In
PCB Thickness Recommended (mm) 1.57 mm
Packaging Type Tray
Pitch - Mating Interface (in) 0.040 In
Pitch - Mating Interface (mm) 1.02 mm
Pitch - Term. Interface (in) 0.040 In
Pitch - Term. Interface (mm) 1.02 mm
Plating min: Mating (µin) 50
Plating min: Mating (µm) 1.25
Plating min: Termination (µin) 100
Plating min: Termination (µm) 2.5
Ports 2
Positions / Loaded Contacts 8/8
Surface Mount Compatible (SMC) No
Temperature Range - Operating -40°C to +85°C
Termination Interface: Style Through Hole
Waterproof / Dustproof No
Wire/Cable Type N/A



EU RoHS

**ELV and RoHS
Compliant**
REACH SVHC
Not Reviewed
**Halogen-Free
Status**

China RoHS



**Need more information on product
environmental compliance?**

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of
Compliance, [click here](#)

Please visit the [Contact Us](#) section for any
non-product compliance questions.

Search Parts in this Series
[44248Series](#)

Mates With
FCC 68 Plugs

Electrical

Current - Maximum per Contact	1.5A
Grounding to PCB	Yes
Shielded	Yes
Voltage - Maximum	150V AC (RMS)

Solder Process Data

Duration at Max. Process Temperature (seconds)	5
Lead-free Process Capability	Wave Capable (TH only)
Max. Cycles at Max. Process Temperature	1
Process Temperature max. C	260

Material Info

Reference - Drawing Numbers

Application Specification	AS-43860-001
Packaging Specification	PK-44248-004
Product Specification	PS-43860-003, RPS-43860-004, RPS-43860-007, RPS-43860-008, RPS-43860-013
Sales Drawing	SD-44248-001

This document was generated on 06/08/2010

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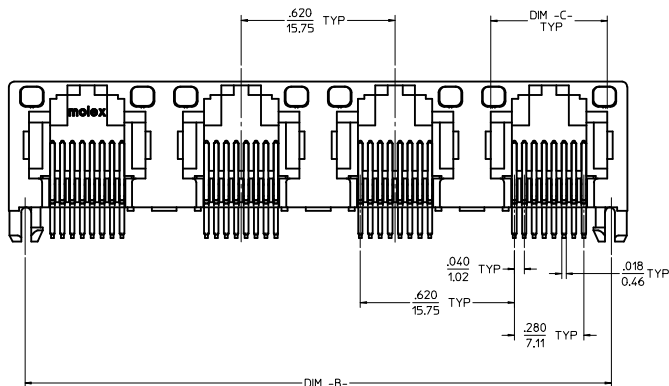
(SNAP-FIT PEG OPTION)

SCALE: NTS
SEE NOTE #8

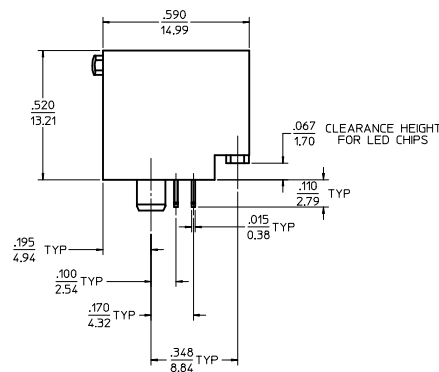


(PRESS-FIT PEG OPTION)

SCALE: NTS
SEE NOTE #8



UNSHIELDED
WITH LIGHT PIPES



8 CIRCUIT HOUSING(S)

ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	DIM -A-	DIM -B-	DIM -C-
44248-0001	8	2	SNAP-FIT	1.250/31.75	1.120/28.45	.469/11.92
44248-0002	8	4	SNAP-FIT	2.490/63.25	2.360/59.94	.469/11.92
44248-0005	8	2	PRESS-FIT	1.250/31.75	1.120/28.45	.469/11.92
44248-0006	8	4	PRESS-FIT	2.490/63.25	2.360/59.94	.469/11.92

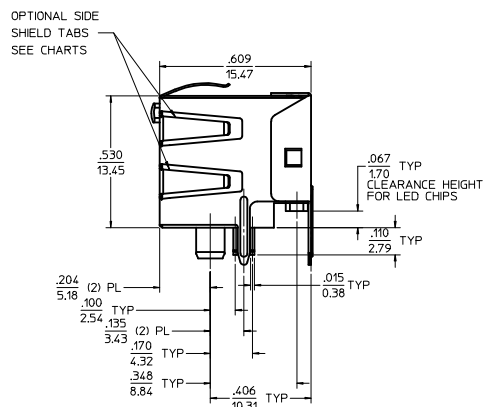
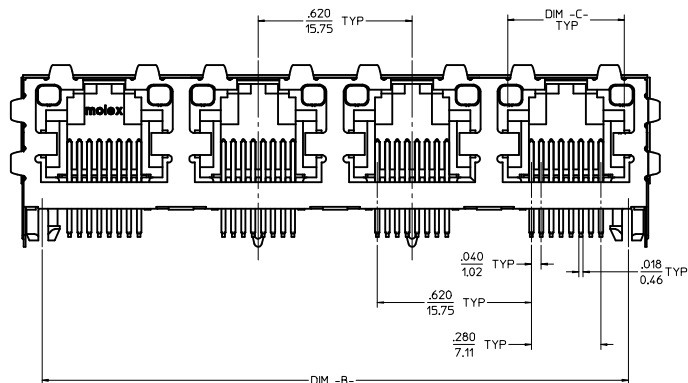
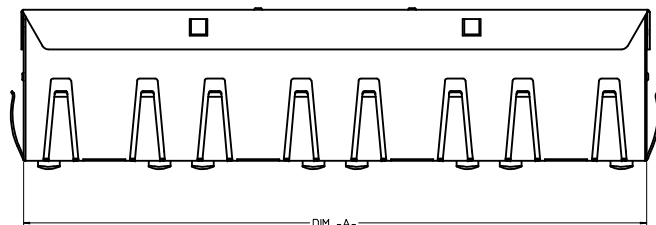
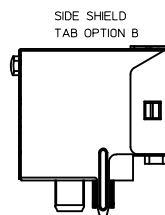
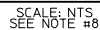
6 CIRCUIT HOUSING(S)

ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	DIM -A-	DIM -B-	DIM -C-
44248-0009	6	2	SNAP-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0010	4	2	SNAP-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0011	6	4	SNAP-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0012	4	4	SNAP-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0017	6	2	PRESS-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0018	4	2	PRESS-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0019	6	4	PRESS-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0020	4	4	PRESS-FIT	2.490/63.25	2.360/59.94	.389/9.88

NOTES:

- MATERIAL:
HOUSING: POLYESTER(PBT), GLASS FILLED, UL94V-0, COLOR: BLACK
LIGHT PIPES: POLYCARBONATE, UL-94V2, COLOR: CLEAR
TERMINALS: PHOSPHOR BRONZE
- FINISH:
TERMINALS:
*SELECT GOLD IN CONTACT AREA: 50 MICROINCHES (127 MICROMETERS) MIN.
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES (2.54 MICROMETERS) MIN.
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES (127 MICROMETERS) MIN.
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD IN THE PC TAILS.
- PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43860-003.
- PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES IN THERMOFORMED TRAYS PER MOLEX PACKAGING SPECIFICATION PK-44248-004.
- APPLICATION SPECIFICATION: AS-43860-001
- ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
- CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
- MODJACKS AVAILABLE WITH EITHER SNAP-FIT OR PRESS-FIT PEGS.
THIS DRAWING SHOWS SNAP-FIT PEGS.
- PCB LAYOUT AND PANEL CUT-OUT SHOWN ON SHEETS (5) AND (6).
- THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-45499-002.

CHGD 0117 TO 0119 EC NO: UCP2009-1482 DRAWN BY: KLOSTER 2008/12/10 CHKD BY: IELL 2008/12/10 APPR:FSM:TH 2008/12/10 REV C4	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1		DESIGN UNITS INCH		THIRD ANGLE PROJECTION	
		mm INCH		DRAWN BY DATE		TITLE		GANGED INVERTED MODJACK ASSEMBLY			
		4 PLACES ±--- ±---		MMAYO 98/10/06		MOLEX INCORPORATED					
		3 PLACES ±--- ±.010		CHECKED BY DATE							
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	SIZE D	2 PLACES ±0.25 ±---		JROBERTS 98/10/06		SD-44248-001		SHEET NO. 1 OF 6			
		1 PLACE ±--- ±---		APPROVED BY DATE							
		ANGULAR ±1/2°		JROBERTS 98/10/06							
		SEE CHART		MATERIAL NO.		DOCUMENT NO.					
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION											

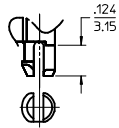


(6) CIRCUIT HOUSING(S)							
ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	SIDE SHIELD TAB OPTION	DIM -A-	DIM -B-	DIM -C-
44248-0037	6	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0038	4	2	SNAP-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0039	6	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
44248-0040	4	4	SNAP-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
44248-0045	6	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0046	4	2	PRESS-FIT	A	1.274/32.36	1.120/28.45	.389/9.88
44248-0047	6	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.389/9.88
44248-0048	4	4	PRESS-FIT	A	2.514/63.86	2.360/59.94	.389/9.88

- NOTES:
- 1) MATERIAL:
HOUSING: POLYESTER(PBT), GLASS FILLED, UL94V-0, COLOR: BLACK
LIGHT PIPES: POLYCARBONATE, UL-94V2, COLOR: CLEAR
TERMINALS: PHOSPHOR BRONZE
SHIELD: BRASS
 - 2) FINISH:
TERMINALS:
SELECT GOLD IN CONTACT AREA: 50 MICROINCHES (1.27 MICROMETERS) MIN.
SELECT TIN IN PC TAIL AREA: 100 MICROINCHES (2.54 MICROMETERS) MIN.
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES (1.27 MICROMETERS) MIN.
SHIELD:
*100 MICROINCHES (2.54 MICROMETERS) NICKEL OVER 50 MICROINCHES (1.27 MICROMETERS) COPPER UNDERPLATE PCB GROUND TABS DIPPED IN TIN
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS
DIRECTIVE 2002/95/EC AND ELV ANNEX I OF DIRECTIVE 2000/53/EC",
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD IN
THE PCB TALS AND/OR SHIELD.
 - 3) PRODUCT SPECIFICATIONS AND PROCESSING PARAMETERS: PS-43860-003.
 - 4) PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES IN THERMOFORMED TRAYS PER MOLEX PACKAGING
SPECIFICATION PK-42248-004.
 - 5) APPLICATION SPECIFICATION: AS-43860-001
 - 6) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
 - 7) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
 - 8) MOD JACKS AVAILABLE WITH EITHER SNAP-FIT OR PRESS-FIT PEGS.
THIS DRAWING SHOWS SNAP-FIT PEGS.
 - 9) PCB LAYOUT AND PANEL CUT-OUT SHOWN ON SHEETS (5) AND (6).
 - 10) THIS PACK CONFORMS TO CLASS-B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.

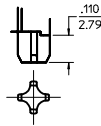
SHIELDED
WITH LIGHT PIPES

SEE SHEET 1 EC NO: UCT2009-1482 DRAWING KLOSTERER 2008/12/10 CHCK: BELL 2008/12/10 APPR: FRYH 2008/12/10	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION															
	=0 =0	<table><tr><td></td><td>mm</td><td>INCH</td></tr><tr><td>4 PLACES</td><td>± --- ± ---</td><td>± --- ± ---</td></tr><tr><td>3 PLACES</td><td>± --- ± ---</td><td>± .010 ± ---</td></tr><tr><td>2 PLACES</td><td>± .025 ± ---</td><td>± --- ± ---</td></tr><tr><td>1 PLACE</td><td>± --- ± ---</td><td>± --- ± ---</td></tr></table>		mm	INCH	4 PLACES	± --- ± ---	± --- ± ---	3 PLACES	± --- ± ---	± .010 ± ---	2 PLACES	± .025 ± ---	± --- ± ---	1 PLACE	± --- ± ---	± --- ± ---		DRAWN BY MMAVY	DATE 98/10/06	TITLE GANGED INVERTED MODJACK ASSEMBLY		
		mm	INCH																				
	4 PLACES	± --- ± ---	± --- ± ---																				
	3 PLACES	± --- ± ---	± .010 ± ---																				
2 PLACES	± .025 ± ---	± --- ± ---																					
1 PLACE	± --- ± ---	± --- ± ---																					
			CHECKED BY JROBERTS	DATE 98/10/06																			
			APPROVED BY JROBERTS	DATE 98/10/06	MOLEX INCORPORATED																		
	DESCRIPTION	ANGULAR ±1/2°		MATERIAL NO.		DOCUMENT NO.	SHEET NO.																
	REV	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-44248-001		2 OF 6															
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION																							



SNAP-FIT PEG OPTION

SCALE: NTS
SEE NOTE #7



PRESS-FIT PEG OPTION

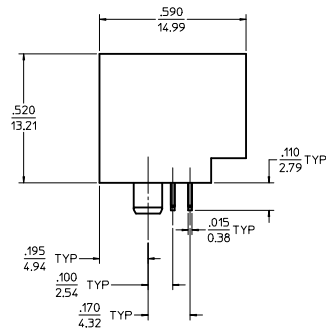
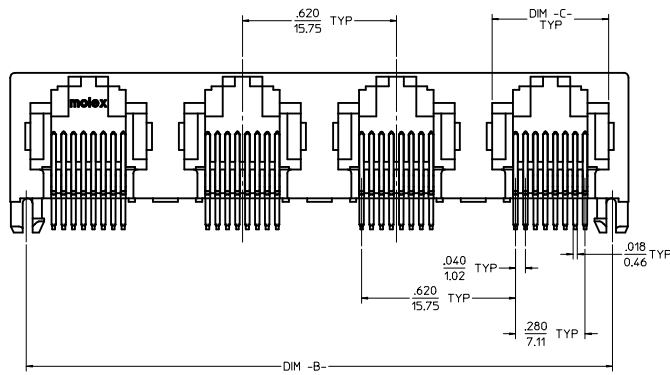
SCALE: NTS
SEE NOTE #7

8 CIRCUIT HOUSING(S)

ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	DIM -A-	DIM -B-	DIM -C-
44248-0057	8	2	SNAP-FIT	1.250/31.75	1.120/28.45	.469/11.92
44248-0058	8	4	SNAP-FIT	2.490/63.25	2.360/59.94	.469/11.92
44248-0061	8	2	PRESS-FIT	1.250/31.75	1.120/28.45	.469/11.92
44248-0062	8	4	PRESS-FIT	2.490/63.25	2.360/59.94	.469/11.92

6 CIRCUIT HOUSING(S)

ASSEMBLY MATERIAL NUMBER	NUMBER OF CIRCUITS	NUMBER OF PORTS	PEG STYLE	DIM -A-	DIM -B-	DIM -C-
44248-0065	6	2	SNAP-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0066	4	2	SNAP-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0067	6	4	SNAP-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0068	4	4	SNAP-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0073	6	2	PRESS-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0074	4	2	PRESS-FIT	1.250/31.75	1.120/28.45	.389/9.88
44248-0075	6	4	PRESS-FIT	2.490/63.25	2.360/59.94	.389/9.88
44248-0076	4	4	PRESS-FIT	2.490/63.25	2.360/59.94	.389/9.88



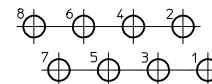
- NOTES:
- MATERIAL:
HOUSING: POLYESTER(PBT), GLASS FILLED, UL94V-0, COLOR: BLACK
TERMINALS: PHOSPHOR BRONZE
 - FINISH:
TERMINALS:
SELECT GOLD IN CONTACT AREA: 50 MICROINCHES (127 MICROMETERS) MIN.
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES (2.54 MICROMETERS) MIN.
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES (127 MICROMETERS) MIN.
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO ROHS
DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD
IN THE PC TAILS.
 - PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43860-003.
 - PACKAGING SPECIFICATION:
CONNECTOR ASSEMBLIES IN THERMOFORMED TRAYS PER MOLEX PACKAGING
SPECIFICATION PK-44248-004.
 - ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
 - CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.
 - MODJACKS AVAILABLE WITH EITHER SNAP-FIT OR PRESS-FIT PEGS.
THIS DRAWING SHOWS SNAP-FIT PEGS.
 - PCB LAYOUT AND PANEL CUT-OUT SHOWN ON SHEETS (5) AND (6).
 - THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.

UNSHIELDED

SEE SHEET 1 EC NO: UCP2009-1482 DRAWN: KLOSTERMEIER 2008/12/10 CHKD: J.BELL 2008/12/10 APPROVED: SMITH 2008/12/10 C4	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1		DESIGN UNITS INCH		 THIRD ANGLE PROJECTION
		mm		DATE		DATE		DATE		
		INCH		DATE		DATE		DATE		
		DATE		DATE		DATE		DATE		
		DATE		DATE		DATE		DATE		
		DATE		DATE		DATE		DATE		
		DATE		DATE		DATE		DATE		
		DATE		DATE		DATE		DATE		
		DATE		DATE		DATE		DATE		
		DATE		DATE		DATE		DATE		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO. SEE CHART		DOCUMENT NO. SD-44248-001		SHEET NO. 3 OF 6				



NUMBER OF PORTS	DIM -B-	DIM -C-
2	1.120/28.45	1.280/32.51
4	2.360/59.94	2.520/64.01



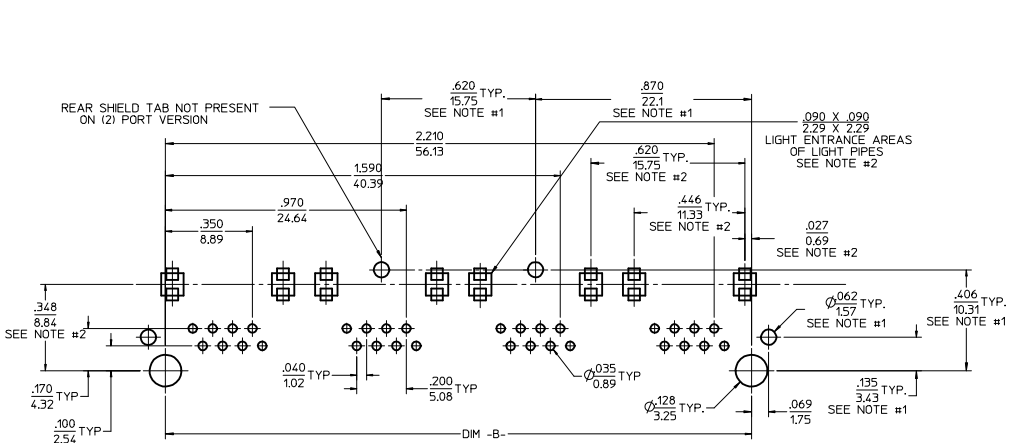
TYPICAL PC TERMINAL HOLE LAYOUT
(8) CIRCUIT CONFIGURATION
SCALE: 10:1

NOTES:

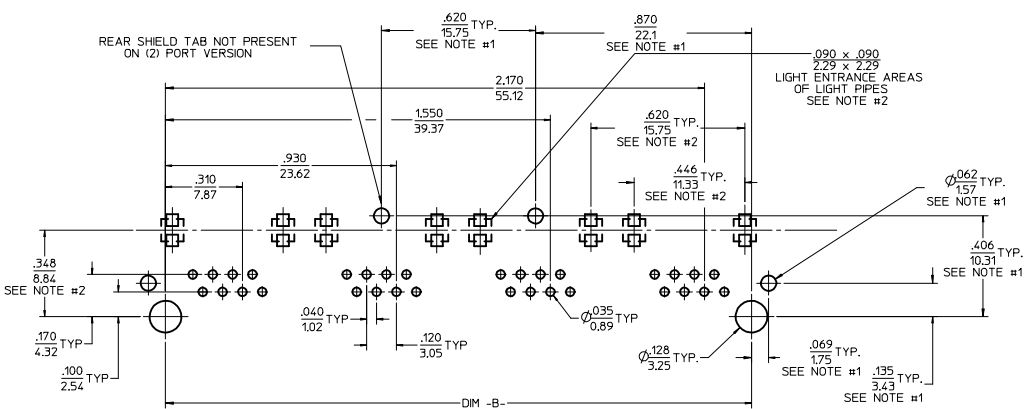
- 1) DIMENSIONS MARKED "SEE NOTE #1" REFER TO ASSEMBLIES WITH THE SHIELDING OPTION INCLUDED
- 2) DIMENSIONS MARKED "SEE NOTE #2" REFER TO ASSEMBLIES WITH THE LIGHT PIPE OPTION INCLUDED
- 3) FOR CROSS REFERENCE OF RECOMMENDED LEDS SEE MOLEX WEB SITE.

SEE SHEET 1 REC NO: UCP2009-1482 DRAWING: MOLEX EPR 2008/12/10 CHKD: BELL APPR: F-SH 2008/12/10	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION	
	▽=0 ▽=0.010 ▽=0.25 ▽=0.010	mm	INCH	DRAWN BY	DATE	TITLE	4:1	INCH	
		4 PLACES ±.010		MMAYO	98/10/06	GANGED INVERTED MODJACK ASSEMBLY			
		3 PLACES ±.010		CHECKED BY	DATE				
		2 PLACES ±0.25		JROBERTS	98/10/06				
		1 PLACE ±.010		APPROVED BY	DATE				
		ANGULAR ±1/2°		JROBERTS	98/10/06	MOLEX INCORPORATED			
				MATERIAL NO.		DOCUMENT NO.		SHEET NO.	
				N/A		SD-44248-001		5 OF 6	
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

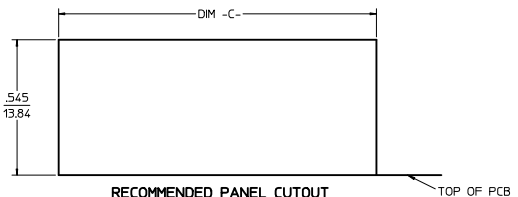
20 19 18 17 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1



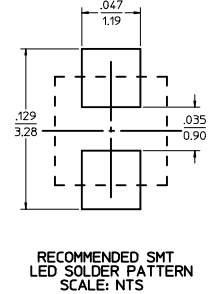
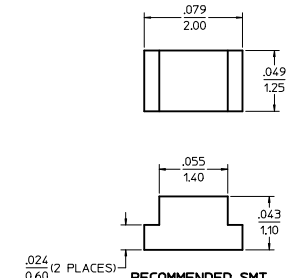
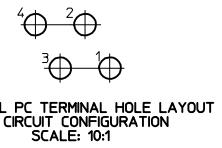
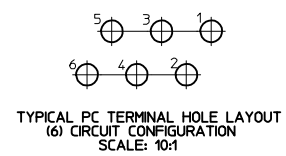
6 CIRCUIT PCB LAYOUT: COMPONENT SIDE
RECOMMENDED PCB THICKNESS: .062/157
TOLERANCE ±.003/076 UNLESS OTHERWISE SPECIFIED



4 CIRCUIT PCB LAYOUT: COMPONENT SIDE
RECOMMENDED PCB THICKNESS: .062/157
TOLERANCE ±.003/076 UNLESS OTHERWISE SPECIFIED



NUMBER OF PORTS	DIM -B-	DIM -C-
2	1.120/28.45	1.280/32.51
4	2.360/59.94	2.520/64.01



- NOTES:
- 1) DIMENSIONS MARKED "SEE NOTE #1" REFER TO ASSEMBLIES WITH SHIELDING OPTION INCLUDED
 - 2) DIMENSIONS MARKED "SEE NOTE #2" REFER TO ASSEMBLIES WITH THE LIGHT PIPE OPTION INCLUDED
 - 3) FOR CROSS REFERENCE OF RECOMMENDED LEDS SEE MOLEX WEB SITE.

SEE SHEET 1 REV C4 DEC NO: UCP2009-1482 DRAWN: KLOSTERMEIER 2008/12/10 CHKD: BELL 2008/12/10 APPROV: SMITH 2008/12/10	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED): mm INCH 4 PLACES ±.010 3 PLACES ±.010 2 PLACES ±.025 1 PLACE ±.050 ANGULAR ±1/2° DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	DIMENSION STYLE IN/MM SCALE 4:1 DESIGN UNITS INCH THIRD ANGLE PROJECTION	TITLE GANGED INVERTED MODJACK ASSEMBLY
	MATERIAL NO. N/A		DOCUMENT NO. SD-44248-001	
	SHEET NO. 6 OF 6		MOLEX INCORPORATED	
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Данный компонент на территории Российской Федерации

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<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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